

## 1812 Series

### 1. Summary

- (a) **RoHS Compliant (Lead Free) Product**
- (b) **Applications: All high-density boards**
- (c) **Product Features: Small surface mountable, Solid state, Faster time to trip than standard SMD devices, Lower resistance than standard SMD devices**
- (d) **Operation Current: 140mA~3.0A**
- (e) **Maximum Voltage: 6V~60V**
- (f) **Temperature Range : - 4 0 °C t o 85°C**

### 2. Electrical Characteristics ( 2 3 °C )

Part Number	Hold Current	Trip Current	Rated Voltage	Max Current	Typical Power	Max Time to Trip		Resistance Tolerance	
						Current	Time	R <sub>MIN</sub>	R <sub>1MAX</sub>
	I <sub>H</sub> , A	I <sub>T</sub> , A	V <sub>MAX</sub> ,	I <sub>MAX</sub> , A	Pd, W	Amp	Sec	Ω	Ω
SMD014	0.14	0.30	60	10	0.8	8.0	0.008	1.20	6.50
SMD020	0.20	0.40	30	10	0.8	8.0	0.02	0.80	5.00
SMD035	0.35	0.70	16	40	0.8	8.0	0.10	0.32	1.50
SMD050	0.50	1.00	16	40	0.8	8.0	0.15	0.15	1.00
SMD075	0.75	1.50	16	40	0.8	8.0	0.20	0.11	0.45
SMD110	1.10	2.20	6	40	0.8	8.0	0.30	0.04	0.21
SMD110-16	1.10	1.95	16	40	0.8	8.0	0.50	0.04	0.18
SMD125	1.25	2.50	6	40	0.8	8.0	0.40	0.05	0.14
SMD150	1.50	3.00	6	40	0.8	8.0	0.50	0.04	0.11
SMD160	1.60	3.20	6	40	0.8	8.0	0.50	0.03	0.10
SMD200	2.00	3.50	8	40	0.8	8.0	2.00	0.02	0.07
SMD260R	2.60	5.00	6	100	1.0	8.0	2.50	0.015	0.047
SMD300	3.00	5.00	6	100	1.0	8.0	4.00	0.012	0.040

I<sub>H</sub>=Hold current-maximum current at which the device will not trip at 23 °C still air.

I<sub>T</sub>=Trip current-minimum current at which the device will always trip at 23 °C still air.

V<sub>MAX</sub>=Maximum voltage device can withstand without damage at it rated current.(I<sub>MAX</sub>)

I<sub>MAX</sub>= Maximum fault current device can withstand without damage at rated voltage (V<sub>MAX</sub>).

Pd=Typical power dissipated-type amount of power dissipated by the device when in the tripped state in 23 °C still air environment.

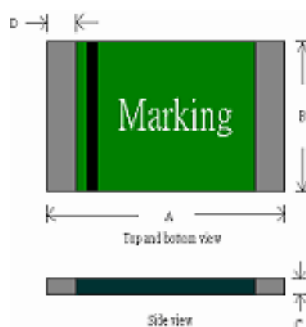
R<sub>MIN</sub>=Minimum device resistance at 23 °C prior to tripping.

R<sub>1MAX</sub>=Maximum device resistance at 23 °C measured 1 hour post trip.

Termination pad characteristics

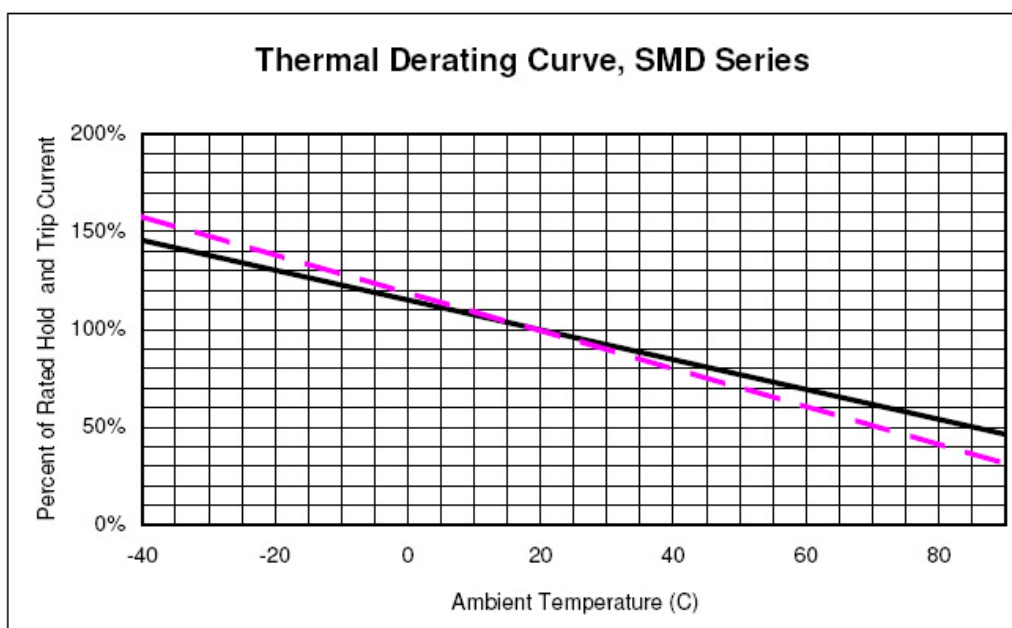
Termination pad materials: Tin Plated Copper

### 3. SMD Product Dimensions (Millimeters)



Part Number	A		B		C		D
	Min	Max	Min	Max	Min	Max	Min
SMD014	4.37	4.73	3.07	3.41	0.60	0.90	0.30
SMD020	4.37	4.73	3.07	3.41	0.60	0.90	0.30
SMD035	4.37	4.73	3.07	3.41	0.40	0.70	0.30
SMD050	4.37	4.73	3.07	3.41	0.35	0.65	0.30
SMD075	4.37	4.73	3.07	3.41	0.35	0.65	0.30
SMD110	4.37	4.73	3.07	3.41	0.25	0.55	0.30
SMD110-16	4.37	4.73	3.07	3.41	0.25	0.90	0.30
SMD125	4.37	4.73	3.07	3.41	0.25	0.55	0.30
SMD150	4.37	4.73	3.07	3.41	0.25	0.55	0.30
SMD160	4.37	4.73	3.07	3.41	0.25	0.90	0.30
SMD200	4.37	4.73	3.07	3.41	0.50	0.90	0.30

### 4. Thermal Derating Curve



A= SMD 075, 110, 110-16, 125, 150, 160 & 200  
B= SMD 014, 020, 035, 050